

low profile T<sup>2</sup>I COMPATIBLE LOGIC

- T<sup>2</sup>L input and outputs
- Delays stable and precise
- 14-pin DIP package
- Leads thru-hole, J, Gull Wing or Tucked
- Available in delays from 15 to 1000ns
- Output and nine (9) taps each isolated and with 10 T2L fan-out capacity
- Fast rise time on all outputs

## design notes

The 'DIP Series' Logic Delay Modules developed by Engineered Components Company have been designed to provide precise tapped delays with required driving and pick-off circuitry contained in a single 14-pin DIP package compatible with FAST and Schottky T<sup>2</sup>L circuits. These logic delay modules are of hybrid construction utilizing the proven technologies of active integrated circuitry and of passive networks utilizing capacitive, inductive and resistive elements. The MTBF on these modules, when calculated per MIL-HDBK-217 for a 50°C ground fixed environment, is in excess of 2 million hours. Module design includes compensation for propagation delays and incorporates internal termination at the output; no additional external components are needed to obtain the desired delay.

The EFXLDM-TTL is offered in 27 delays from 15 to 1000ns with each module incorporating total output and nine (9) taps. Delay tolerances are maintained as shown in the accompanying part number table, when tested under the "Test Conditions" shown. Delay

time is measured at the +1.5V level on the leading edge. Rise time for all modules is 4ns maximum when measured from 0.8V to 2.0V. Temperature coefficient of delay is approximately +400 ppm/°C over the operating temperature range of 0 to +70°C.

These modules accept either logic "1" or logic "0" inputs and reproduce the logic at the output without inversion. The delay modules are intended primarily for use with positive going pulses and are calibrated to the tolerances shown in the table on rising edge delay; where best accuracy is desired in applications using falling edge timing, it is recommended that a special unit be calibrated for the specific application. Each module has the capability of driving up to 20 Schottky T<sup>2</sup>L loads with a maximum of 10 loads on any one tap.

These "DIP Series" modules are packaged in a 14-pin DIP housing, molded of flame-proof Diallyl Phthalate per MIL-M-14, Type SDG-F, and are fully encapsulated in epoxy resin. Thruhole, J, Gull Wing or Tucked Lead configurations are available on these modules (see Part Number Table note to specify). Leads meet the solderability requirements of MIL-STD-202, Method 208. Corner standoffs on the housing of the thru-hole lead version and lead design of the surface mount versions provide positive standoff from the printed circuit board to permit solder-fillet formation and flush cleaning of solder-flux residues for improved reliability.

Marking consists of manufacturer's name, logo (EC2), part number, terminal identification and date code of manufacture. All marking is applied by silk screen process using white epoxy paint in accordance with MIL-STD-130, to meet the permanency of identification required by MIL-STD-202, Method 215.



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Pin No.

Pin No.

.060

→I - 010

010

-010

260

400

.425

425

425

.030 TYP.

.030TYP.--

285

.030 TYP.→

14 13 12 11 10 9 8

Thru-hole Lead

\*Gull Wing Lead

40-0-0-0-0-0-0

U

\*J Lead

\*Tucked Lead

1 3 5 7 9 OUT EFXLDM-

6 8

130 ±.010

100 TYP.

¥ 300

100 TYP.

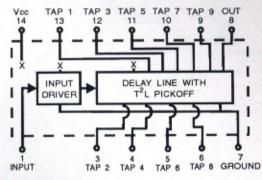
100 TYP.

.445 REF.

.100 TYP.

385

## **BLOCK DIAGRAM IS SHOWN BELOW**



## **TEST CONDITIONS**

- 1. All measurements are made at 25°C.
- 2. Vcc supply voltage is maintained at 5.0V DC.
- All units are tested using a Schottky toggle-type positive input pulse and one Schottky load at the output being tested.
- Ø 4. Input pulse width used is 5 to 10ns longer than delay of module under test; spacing between pulses (falling edge to rising edge) is three times the pulse width used.

## **OPERATING SPECIFICATIONS**

Logic 1 Voltage out: . .

Logic 0 Voltage out: . . .

Operating temperature range: . .

Storage temperature: . . . .

*V <sub>∞</sub> supply voltage:	4.75 to 5.25V DC
V <sub>CC</sub> supply current: Constant "0" in	45mA typical
Constant "1" in	15mA typical
Logic 1 Input:	, ,
Voltage	2V min.; Vcc max.
Current	2.7V = 20uA max. 5.5V = 1mA max.
Logic 0 Input:	
Voltage	
Current	6mA max.

\* Delays increase or decrease approximately 2% for a respective increase or decrease of 5% in supply voltage.

2.7V min.

.5V max.

0 to 70°C

-55 to +125°C.

PART NUMBER TABLE
\*Suffix Part Number with
G (for Gull Wing Lead), J
(for J Lead), F (for Thruhole Lead) or T (for
Tucked Lead). Examples:
EFXLDM-TTL-50G (Gull
Wing), EFXLDM-TTL-70J
(J Lead), EFXLDM-TTL80F (Thru-hole Lead) or
EFXLDM-TTL-90T
(Tucked Lead).

PART NO.	TAP 1	TAP 2	TAP 3	TAP 4	TAP 5	TAP 6	TAP 7	TAP 8	TAP 9	OUTPUT
EFXLDM-TTL-15	6 ±1	7 ±1	8 ±1	9 ±1	10 ±1	11 ±1	12 ±1	13 ±1	14 ±1	15 ±1
EFXLDM-TTL-19.5	6 ±1	7.5 ±1	9 ±1	10.5 ±1	12 ±1	13.5 ±1	15 ±1	16.5 ±1	18 ±1	19.5 ± 1
EFXLDM-TTL-24	6 ±1	8 ±1	10 ±1	12 ±1	14 ±1	16 ±1	18 ±1	20 ±1	22 ±1	24 ±1
EFXLDM-TTL-28.5	6 ±1	8.5 ±1	11 ±1	13.5 ±1	16 ±1	18.5 ±1	21 ±1	23.5 ±1	26 ±1.5	28.5 ±1.5
EFXLDM-TTL-33	6 ±1	9 ±1	12 ±1	15 ±1	18 ±1	21 ±1	24 ±1	27 ±1.5	30 ±1.5	33 ±1.5
EFXLDM-TTL-42	6 ±1	10 ±1	14 ±1	18 ±1	22 ±1	26 ±1.5	30 ±1.5	34 ±1.5	38 ±2	42 ±2
EFXLDM-TTL-50	5 ±1	10 ±1	15 ±1	20 ±1	25 ±1.5	30 ±1.5	35 ±1.5	40 ±2	. 45 ±2	50 ±2
EFXLDM-TTL-60	6 ±1	12 ±1	18 ±1	24 ±1	30 ±1.5	36 ±1.5	42 ±2	48 ±2	54 ±2	60 ±2.5
EFXLDM-TTL-70	7 ±1	14 ±1	21 ±1	28 ±1.5	35 ±1.5	42 ±2	49 ±2	56 ±2	62 ±2.5	70 ±2.5
EFXLDM-TTL-80	8 ±1	16 ±1	24 ±1	32 ±1.5	40 ±2	48 ±2	56 ±2	64 ±2.5	72 ±2.5	80 ±3
EFXLDM-TTL-90	9 ±1	18 ±1	27 ±1.5	36 ±1.5	45 ±2	54 ±2	63 ±2.5	72 ±2.5	81 ±3	90 ±3
EFXLDM-TTL-100	10 ±1	20 ±1	30 ±1.5	40 ±2	50 ±2	60 ±2.5	70 ±2.5	80 ±3	90 ±3	100 ±3
EFXLDM-TTL-125	12.5 ±1	25 ±1.5	37.5 ±2	50 ±2	62.5 ±2.5	75 ±2.5	87.5 ±3	100 ±3	112.5 ±4	125 ±4
EFXLDM-TTL-150	15 ±1	30 ±1.5	45 ±2	60 ±2.5	75 ±2.5	90 ±3	105 ±4	120 ±4	135 ±4	150 ±5
EFXLDM-TTL-175	17.5 ±1	35 ±2	52.5 ±2	70 ±2.5	87.5 ±3	105 ±4	122.5 ±4	140 ±5	157.5 ±5	175 ±5
EFXLDM-TTL-200	20 ±1	40 ±2	60 ±2.5	80 ±3	100 ±3	120 ±4	140 ±5	160 ±5	180 ±6	200 ±6
EFXLDM-TTL-250	25 ±1.5	50 ±2	75 ±2.5	100 ±3	125 ±4	150 ±5	175 ±5	200 ±6	225 ±7	250 ±B
EFXLDM-TTL-300	30 ±1.5	60 ±2.5	90 ±3	120 ±4	150 ±5	180 ±6	210 ±7	240 ±7	270 ±8	300 ±9
EFXLDM-TTL-350	35 ±1.5	70 ±2.5	105 ±4	140 ±5	175 ±5	210 ±7	245 ±8	280 ±9	315 ±10	350 ±11
EFXLDM-TTL-400	40 ±2	80 ±3	120 ±4	160 ±5	200 ±6	240 ±7	280 ±9	320 ±10	360 ±11	400 ±12
EFXLDM-TTL-450	45 ±2	90 ±3	135 ±4	180 ±6	225 ±7	270 ±8	315 ±10	360 ±11	405 ±12	450 ±14
EFXLDM-TTL-500	50 ±2	100 ±3	150 ±5	200 ±6	250 ±8	300 ±9	350 ±11	400 ±12	450 ±14	500 ±15
EFXLDM-TTL-600	60 ±2.5	120 ±4	180 ±5	240 ±7	300 ±9	360 ±11	420 ±13	480 ±15	540 ±16	600 ±18
EFXLDM-TTL-700	70 ±2.5	140 ±5	210 ±7	280 ±9	350 ±11	420 ±13	490 ±15	560 ±17	630 ±19	700 ±20
EFXLDM-TTL-800	80 ±3	160 ±5	240 ±7	320 ±10	400 ±12	480 ±15	560 ±17	640 ±19	720 ±20	800 ±20
EFXLDM-TTL-900	90 ±3	180 ±6	270 ±8	360 ±11	450 ±14	540 ±16	630 ±19	720 ±20	810 ±20	900 ±22
EFXLDM-TTL-1000	100 ±3	200 ±6	300 ±9	400 ±12	500 ±15	600 ±18	700 ±20	800 ±20	900 ±22	1000 ±22

All modules can be operated with a minimum input pulse width of 20% of full delay or 5ns min and pulse period approaching square wave; since delay accuracies may be somewhat degraded, it is suggested that the module be evaluated under the intended specific operating conditions. Special modules can be readily manufactured to improve accuracies and/or provide customer specified random delay times for specific applications.

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